

AF
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Xiao-Chun Mu et al.

Title: Microelectronic Package Having an Integrated Heat Sink and Build-Up Layers

Docket No.: 884.798US1

Filed: December 8, 2000

Examiner: DiLinh Nguyen



Serial No.: 09/733,289

Due Date: January 5, 2006

Group Art Unit: 2814

MS AF

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

We are transmitting herewith the following attached items (as indicated with an "X"):

- ☒ Return postcard.
- ☒ Response Under 37 CFR 1.116 (16 pgs.).
- ☒ COPIES of Supplemental Information Disclosure Statement (2 pg.), Form 1449 (1 pg.), 4 cited non-U.S. patent documents, all previously filed July 24, 2003, and date-stamped itemized postcard from same (1 pg.).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: MS AF, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on this 5th day of January, 2006.

Amy Moriarty

Name

Signature

A handwritten signature in black ink, appearing to read "Amy Moriarty", written over a horizontal line.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

(GENERAL)